





#### SURFACE-MOUNT FAST SWITCHING DIODE

### **Features**

- Fast Switching Speed
- Ultra-Small Surface-Mount Package
- For General-Purpose Switching Applications
- High Conductance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

### **Mechanical Data**

- Package: SOD523
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Band
- Terminals: Matte Tin Finish (Lead Free Plating) Annealed over
   Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.002 grams (Approximate)

SOD523



Top View

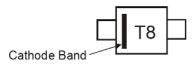
### Ordering Information (Notes 4 & 5)

Part Number (Note 6)	Paskana	Packing		
	Package	Qty.	Carrier	
1N4448HWT-7	SOD523	3000	Tape & Reel	
1N4448HWT-13	SOD523	10000	Tape & Reel	

#### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/
- 5. Products manufactured with date code 0627 (week 27, 2006) and newer are built with green molding compound. Products manufactured prior to date code 0627 are built with non-green molding compound and may contain halogens or Sb<sub>2</sub>O<sub>3</sub> fire retardants.
- 6. Dispensed in every other cavity of the tape.

### **Marking Information**



T8 = Product Type Marking Code A Bar on Top of the Letter 'T' Denotes AT Site



# **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
RMS Reverse Voltage		V <sub>R</sub> (RMS)	57	V
Forward Continuous Current		lғм	250	mA
Non-Repetitive Peak Forward Surge Current	@t = 1.0µs @t = 1.0s	IFSM	2.0 1.0	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 7)	PD	150	mW
Thermal Resistance Junction to Ambient (Note 7)	Reja	833	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

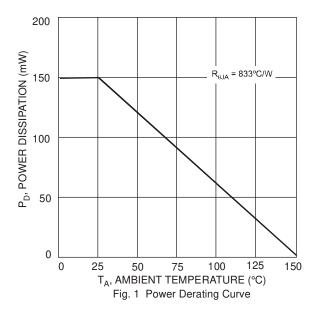
# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

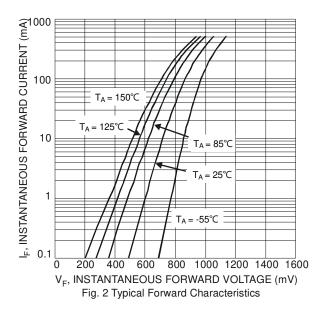
Characteristic	Symbol	Min	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 8)	$V_{(BR)R}$	80	_	V	$I_R = 100\mu A$
	V <sub>F</sub> 0.6	0.62	0.72	V	IF = 5.0mA
Forward Voltage		_	0.855		IF = 10mA
o o ward voltage	٧F	_	1.0		IF = 100mA
		_	1.25		I <sub>F</sub> = 150mA
		_	100	nA	V <sub>R</sub> = 80V
Peak Reverse Current (Note 8)	1-	_	50	μΑ	$V_R = 75V, T_J = +150$ °C
reak neverse current (Note o)	IR	_	30	μA	$V_R = 25V, T_J = +150$ °C
		_	25	nA	$V_R = 20V$
Total Capacitance	Ст	_	3.0	pF	$V_R = 0.5V, f = 1.0MHz$
Reverse Recovery Time	+		<b>—</b> 4.0	ns	$I_F = I_R = 10mA$
neverse necovery fillie	t <sub>rr</sub>				$I_{rr} = 0.1 \text{ x } I_{R}, R_{L} = 100\Omega$

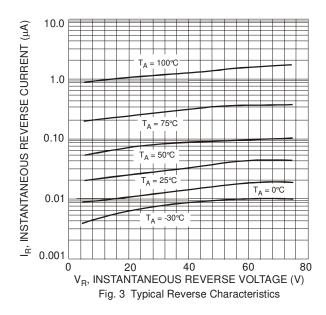
Notes:

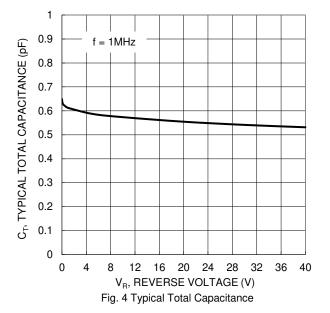
<sup>7.</sup> Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html. 8. Short duration pulse test used to minimize self-heating effect.









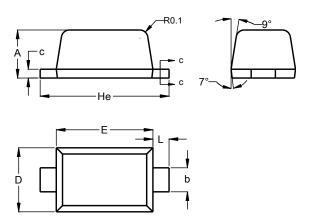




## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOD523

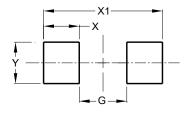


SOD523			
Dim	Min	Max	
Α	0.55	0.65	
b	0.26	0.34	
С	0.11	0.17	
D	0.75	0.85	
Е	1.15	1.25	
He	1.55 1.65		
L	0.10	0.30	
All Dimensions in mm			

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SOD523



Dimensions	Value (in mm)
G	0.80
Х	0.60
X1	2.00
V	0.70



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